

Model No: WT ÙPË Í JÎ T ÖËH VÁÇÜÒXÖD

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Revision record							
Document	Model No.	Description	Revision				
Revision	Version No.	Description	by				
0	UMSH-8596MD-T (UFSH-K106EY-FT) Version No. 0	7.0" TFT.(backlight luminance $300cd/m^2$)	Y.D. Shie Zi Xin Ou 25-May-2011				
1	UMSH-8596MD-1T (UFSH-K106EY-FT) Version No. 0	Modify the backlight luminance from 300cd/m ² to 500cd/m ² .	Y.D. Shie Danny Jhuang 11-Aug-2014				
2	UMSH-8596MD-34T Version No. 0	 Add the touch panel IC to ST1633i. Modify the module number from UMSH-8596MD-1T to UMSH-8596MD-34T. 	H.F. Kuo Zi Xin Ou 30-Apr-2015				
3	UMSH-8596MD-34T(REVD) Version No. 0	 Change the TFT panel and backlight. Modify the module number from UMSH-8596MD-34T to UMSH-8596MD-34T(REVD). 	H.F. Kuo Zi Xin Ou 11-Dec-2015				
mmm Mic	rotips LOGY Revision 3; UN	I ISH-8596MD-34T(REVD) Ver. 0 ; December-11-2015	Page: 2				

CONTENTS:

No.	Item	Page
	BASIC SPECIFICATION	
1	1.1 Mechanical Specification	4
	1.2 Display Specification	4
	1.3 Outline Dimension	5
	1.4 Block Diagram	6
	1.5 Interface Pin	7
2	ELECTRICAL CHARACTERISTICS	0
2	2.1 Absolute Maximum Ratings	8
	2.2 DC Characteristics	9
	2.3 Back-light	10
	2.4 AC Characteristics	11~12
	2.5 Capacitive touch panel controller	13
	AC Characteristics	
	2.6 I2C Host Interface Protocol	14~17
	OPTICAL CHARACTERISTICS	
3	3.1 Condition	18
5	3.2 Definition of Optical Characteristics	19~20
4	RELIABILITY	21
5	PRODUCT HANDING AND APPLICATION	22~23
	DATECODE	24
6	DATECODE	24
7	PACKING & LOTNO	25~26
8	INSPECTION STANDARD	27~31
0		27 31

1. BASIC SPECIFICATION

1.1 Mechanical specifications

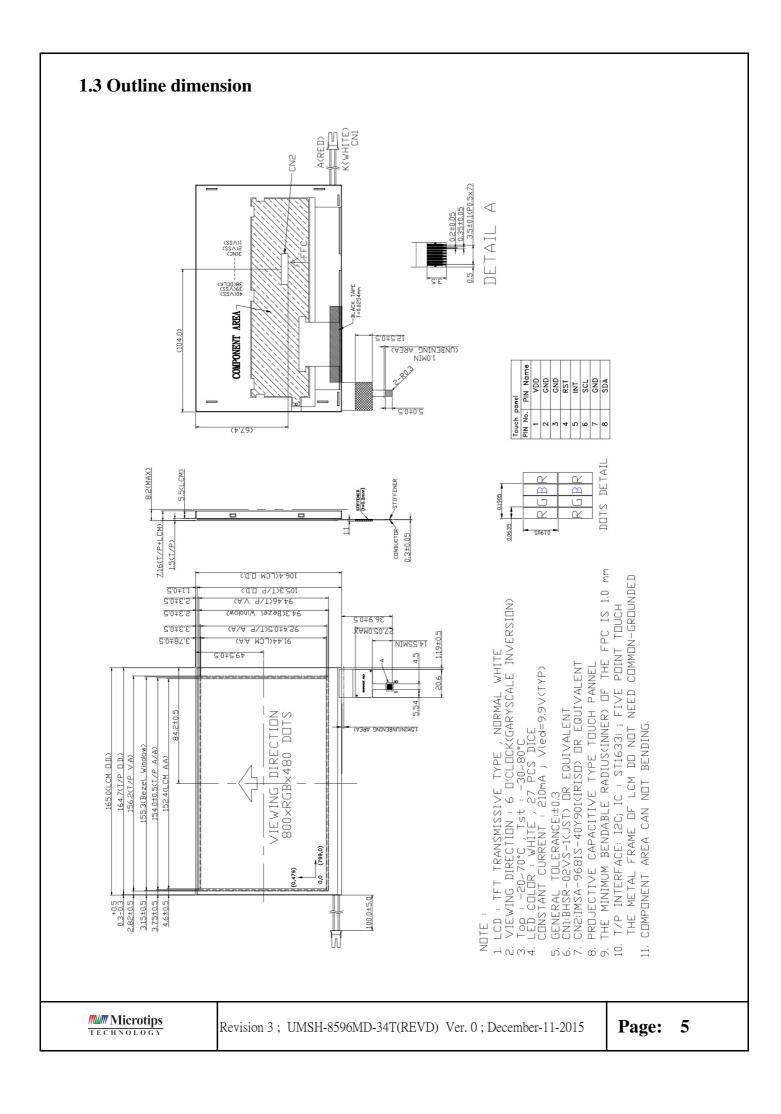
Items	Nominal Dimension	Unit	
Active screen size	7.0" Diagonal	-	
Dot Matrix	800 x RGB x 480	Pixel	
Module Size (W x H x T)	165.0 x 106.4 x 8.2	mm.	
Active Area (W x H)	152.4 x 91.44	mm.	
Pixel Size (W×H)	0.1905 x 0.1905	mm.	
Color depth	262K	color	
Interface	Parallel 18-bit RGB	-	
Driving IC Package	COG	-	
Module weight	195±10%	g	

1.2 Display specification

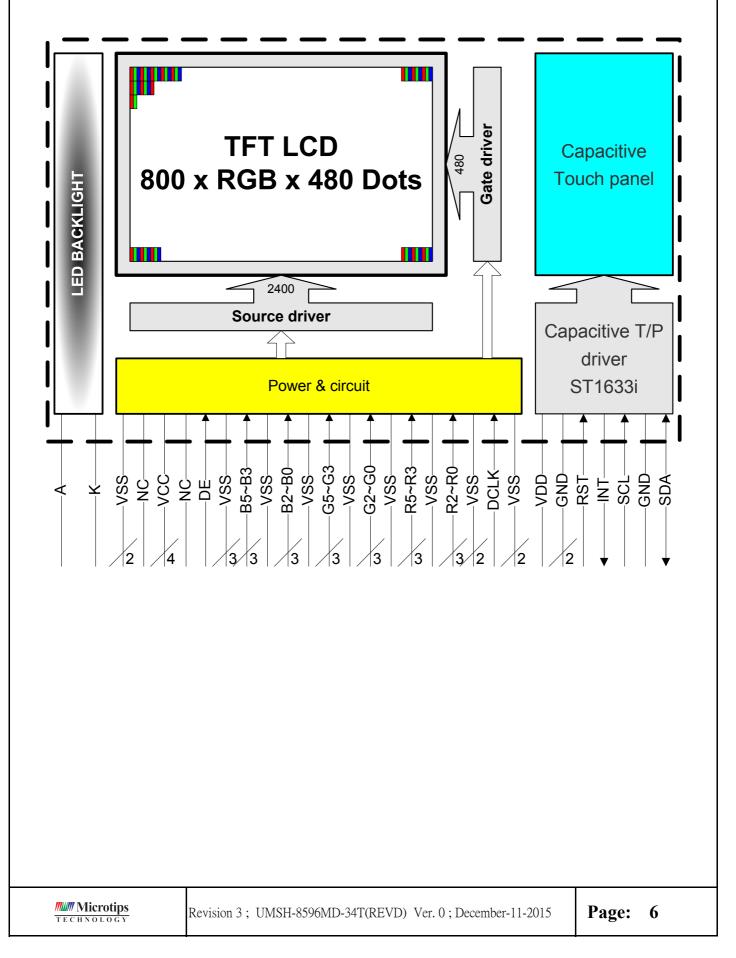
Display	Descriptions	Note
LCD Type	a-Si TFT	-
LCD Mode	TN / Normal white	-
Polarizer Mode	Transmissive	-
Polarizer Surface	Normal	-
Pixel arrangement	RGB-stripe	-
Backlight Type	LED	-
Viewing Direction(Gray inversion)	6 O'clock Direction	1

Color tone is slightly changed by temperature and driving voltage.

Note 1 : The viewing direction defined in this specification is according to the rubbing direction of its TFT surface treatment by the TFT glass manufacturer. The grayscale inversion is at this direction as well. However, the optimal viewing direction for human view is normally where the color does NOT change to grayscale inversion, and this would be the opposite site of the specified viewing direction in this specification. In any case we advise customers to judge by themselves, and be aware of this phenomenon.



1.4 Block diagram:



1.5 Interface Pin Connection:

Pin No.	Pin Symbol	1/0	Description
1~2	VŠS	Ρ	GND
3	NC	-	No connection
4~7	VCC	Р	Power supply for Module (+3.3V)
8	NC	-	No connection
9	DE		Data enable
10~12	VSS	Р	GND
13~15	B5~B3		Blue data input
16	VSS	Ρ	GND
17~19	B2~B0		Blue data input
20	VSS	Ρ	GND
21~23	G5~G3		Green data input
24	VSS	Ρ	GND
25~27	G2~G0		Green data input
28	VSS	Ρ	GND
29~31	R5~R3		Red data input
32	VSS	Ρ	GND
33~35	R2~R0		Red data input
36~37	VSS	Ρ	GND
38	DCLK		Dot clock
39~40	VSS	Р	GND
B/L interfac	ce pin :		
Pin No.	Pin Symbol	1/0	Description
1	Á	Р	Power supply for LED+

Capacitive touch panel (I2C) Interface:

Κ

2

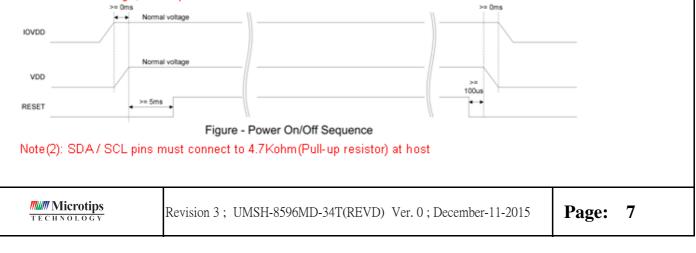
Ρ

oapaolitio	apaolitio todon partoi (120) internaco.						
Pin No.	Pin Symbol	1/0	Description				
1	VDD	P	Power supply. (+3.3V)				
2~3	GND	P	Ground.				
4	RST		System reset signal input, active low. Note (1)				
5	INT	0	Active low when data output from touch panel.				
6	SCL		Serial Clock.				
7	GND	Р	Ground.				
8	SDA	1/0	Serial data access.				

Note(1): Power On/Off Sequence.

Reset pin should be held low before power on and power off. During power on, after VDD reach normal voltage, Reset pin needs to be held low for 5ms to ensure internal block stable.

Power supply for LED-



2. ELECTRICAL CHARACTERISTICS

2.1 Absolute Maximum Ratings

Items	Symbol	Min.	Max.	Unit
Power supply voltage	VCC	-0.3	7.0	V
r ower suppry vonage	VDD	-0.3	6.0	V
Input voltage	Vin	-0.3	VCC+0.3	V
Operate temperature range	Тор	-20	70	°C
Storage temperature range	Тѕт	-30	80	°C

2.2 DC Characteristics

 $T_a=25^{\circ}C$

Items	Symbol	Min.	Тур.	Max.	Unit	Condition
	vcc	-	3.3	-	V	-
Supply voltage	VDD	-	3.3	-	V	-
Input Voltage	Vil	0	-	0.3VCC	V	Llevel
(LCM)	Vн	0.7VCC	-	VCC	V	H level
Input Voltage	Vil	-	-	0.15VDD	V	Llevel
(CTP)	∨н	0.85VDD	-	-	V	H level
	lvcc	-	160	250	mA	Note 1
Current consumption	Ivdd	-	14	28	mA	-

*Note1 :

Measuring Condition:

Standard Value MAX.

 $Ta = 25^{\circ}C$

VCC - GND = 3.3V

Display Pattern



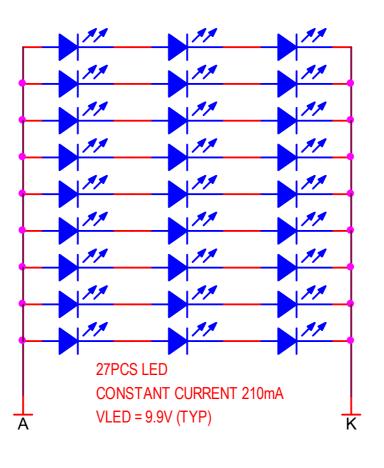
0 gray black pattern

2.3 Back-light only Specification :

PARAMETER	SYMBOL	MIN	ТҮР	MAX	Unit	Test Condition	NOTE
Supply Current	If	-	210	-	mA	Ta=25°C	-
Supply Voltage	Vf	-	9.9	-	v	Ta=25°C	-
Half-Life Time	Lf	-	50000	-	hrs	Ta=25°C	1

Note 1 : The "Half-Life Time" is defined as the LED chip brightness decreases to 50% than original brightness, Based on Ta 25±2°C,60±10% RH condition.

Note 2 : LED backlight is 27 LEDs.



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Revision 3; UMSH-8596MD-34T(REVD) Ver. 0; December-11-2015

2.4 AC Characteristics

Switching characteristics

PARAMETER	Symbol		Spec.		Unit
TANAMETER	Symbol	Min.	Тур.	Max.	Onic
Data setup time	T _{dsu}	6	I	-	ns
Data hold time	T _{dhd}	6	I	I	ns
DE setup time	T _{esu}	6	I	-	ns
Source output settling time	T _{ST}	-		15	μs
Source output loading R	R _{SL}	-	2	-	K ohm
Source output loading C	C _{SL}	-	60		рF

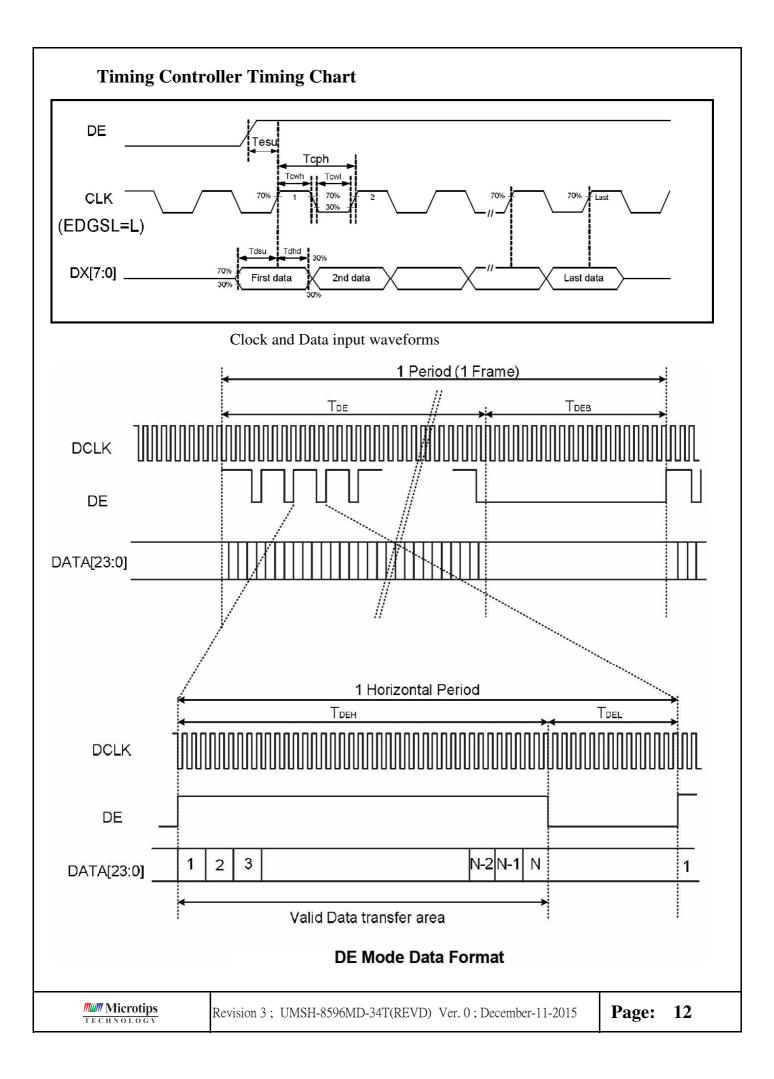
Parallel RGB Input Timing Requirement

DE mode

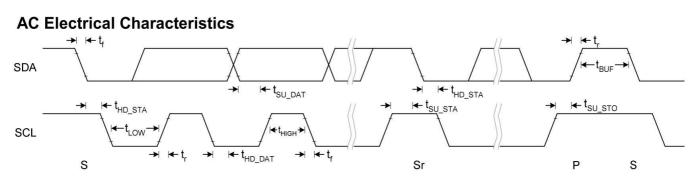
PARAMETER	Symbol		L lució		
FARAWETER	Symbol	Min.	Тур.	Max.	Unit
CLK frequency	F _{CPH}	-	33.26	Ξ.	MHz
CLK period	T _{CPH}	■ 8	30.06	-	ns
CLK pulse duty	T _{CWH}	40	50	60	%
DE period	T _{DEH} +T _{DEL}	1000	1056	1200	T _{CPH}
DE pulse width	T _{DEH}		800	-	T _{CPH}
DE frame blanking	T _{DEB}	10	45	110	T _{DEH} +T _{DEL}
DE frame width	T_DE	-8	480	-	$T_{DEH}+T_{DEL}$

PARAMETER	Symbol		Spec.		Unit
FARAMETER	Symbol	Min.	Тур.	Max.	Onit
OEV pulse width	T _{OEV}	:-	150	-	T _{CPH}
CKV pulse width	Тски		133	-	T _{CPH}
DE(internal)-STV time	T ₁	-	4	-	T _{CPH}
DE(internal)-CKV time	T ₂	i=	40	-	T _{CPH}
DE(internal)-OEV time	T ₃		23		T _{CPH}
DE(internal)-POL time	T ₄		157	-	T _{CPH}
STV pulse width	-	-	1	-	Τ _Η

(i). T_{HS}+T_{HA}<T_H



2-5 Capacitive touch panel controller AC Characteristics



I2C Fast Mode Timing

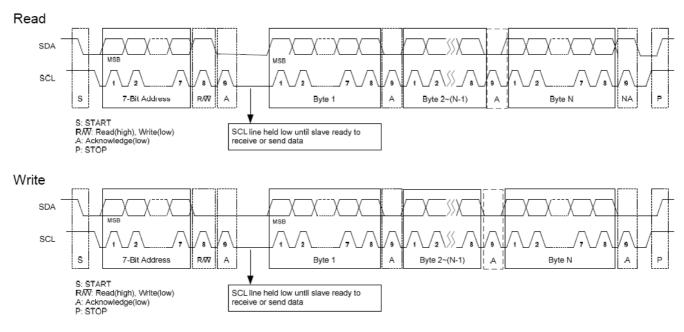
I2C Fast Mode Timing Characteristic

Conditions: VDD = IOVDD = 3.3V, GND = 0V, T_A = $25^{\circ}C$

Symbol	Parameter		Rating		Unit
Gymbol		Min.	Тур.	Max.	
f _{SCL}	SCL clock frequency	0	-	400	kHz
t _{LOW}	Low period of the SCL clock	1.3		-	us
t _{HIGH}	High period of the SCL clock	0.6	-	3-1	us
t _f	Signal falling time	-		300	ns
tr	Signal rising time	a - a	. - .	300	ns
t _{su_sta}	Set up time for a repeated START condition	0.6	-	-	us
t _{hd_sta}	Hold time (repeated) START condition. After this period, the first clock pulse is generated	0.6	-	-	us
t _{su dat}	Data set up time	100	i - i	-	ns
t _{HD DAT}	Data hold time	0	-	0.9	us
t _{su_sto}	Set up time for STOP condition	0.6	-	-	us
t _{BUF}	Bus free time between a STOP and START condition	1.3	-	-	us
Cb	Capacitive load for each bus line	-	-	400	pF

2-6 I2C Host Interface Protocol

2.6.1 I2C Slave Interface



Note : I2C address is default to 0x55 (7-bits address)

2.6.2 Register Read

For reading register value from I2C device, host has to tell I2C device the *Start Register Address* before reading corresponding register value.

I2C Start	I2C Header (W)	Start Reg. Addr. (a)	I2C Stop	I2C Start	I2C Header (R)	Value of Reg(a)	Value of Reg(a+1)	2	Value of Reg(a+n)	I2C Stop	
--------------	----------------------	-------------------------------	-------------	--------------	----------------------	--------------------	----------------------	---	----------------------	-------------	--

Figure 1	- Register	Read	Format.	
----------	------------	------	---------	--

Sitronix Touch IC I2C host interface protocol supports *Repeated Register Read*. That is, once the *Start Register Address* has been set by host, consequent I2C Read(R) transactions will directly read register values starting from the *Start Register Address* without setting address first, as shown in Figure 2.

I2C Start	I2C Header (R)	Value of Reg(a)	Value of Reg(a+1)	Value of Reg(a+n)	I2C Stop	I2C Start	I2C Header (R)	Value of Reg(a)	Value of Reg(a+1)	 Value of Reg(a+n)	I2C Stop
				Figure 2 -	Repeat	ed Regi	ster Read	I.			
He	oder V	alua(D) . 0 1								
IN		alue(K) : 0xab							 	

2.6.3 Register Write

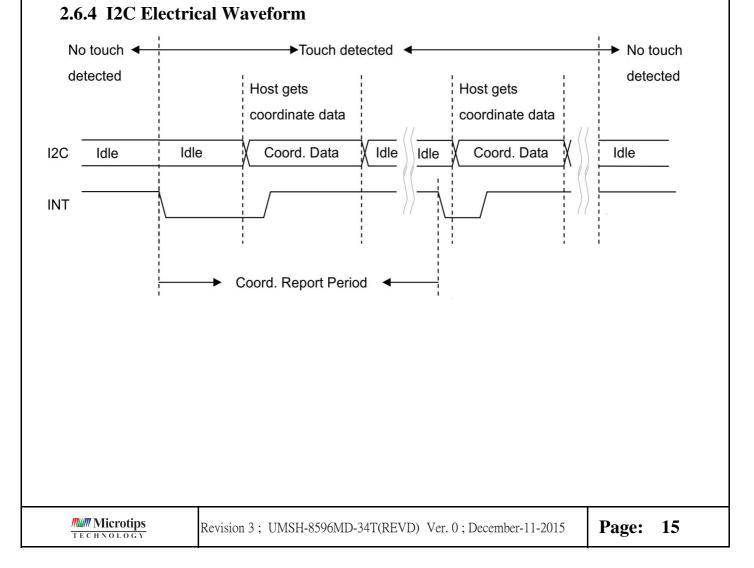
For writing register to I2C device, host has to tell I2C device the Start Register Address in each I2C Register Write transaction. Register values to the I2C device will be written to the address starting from the Start Register Address described in Register Write I2C transaction as shown in Figure 3.

I2CReg.Value toValue toStartHeaderAddr.Reg(a)Reg(a+1)(W)(a)(a)(b)(c)			ldr.		
--	--	--	------	--	--



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Header Value(W) : 0xaa



2.6.5 Registers

Sitronix Touch IC provides a register set for host to configure device attributes and retrieve information about Device Control , XY Coordinates through device host interface. Host interface registers are listed below.

Reg Addr.	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit O
0x00		· · · ·		-	Res	erved	. 1		
0x01						1	. I	Power	
0x02	Device Control Reg		Res	erved		Reserved	Reserved	Down (R/W)	Reset (RM)
0x03	Timeout to Idle Register					oldle (Sec) RM)			
0x04 ~ 0x11					Res	erved			
0x12	XY0 Coord (High Byte)	Valid 0 (RO)		X0_H(RO)		Reserved		Y0_H (RO)	
0x13	X0 Coord (Low Byte)				X0_	L(RO)			
0x1 4	Y0 Coord (Low Byte)				Y0_	L(RO)			
0x15					Res	erved			
0x16	XY1 Coord (High Byte)	Valid 1 (RO)		X1_H(R0)		Reserved		Y1_H (R0)	
0x17	X1 Coord (Low Byte)				X1_	L(RO)			
0x18	Y1 Coord (Low Byte)				Y1_	L(RO)			
0x19					Res	erved			
0x1A	XY2 Coord (High Byte)	Valid 2 (RO)		X2_H(RO)		Reserved		Y2_H (RO)	
0x1B	X2 Coord (Low Byte)				X2_	L(RO)			
0x1C	Y2 Coord (Low Byte)				Y2_	L(RO)			
0x1D					Res	erved			
0x1E	XY3 Coord (High Byte)	Valid 3 (RO)		X3_H(RO)		Reserved		Y3_H (RO)	
0x1F	X3 Coord (Low Byte)				X3_	L(RO)			
0x20	Y3 Coord (Low Byte)				Y3_	L(RO)			
0x21					Res	erved			
0x22	XY4 Coord (High Byte)	Valid 4 (RO)		X4_H(RO)		Reserved		Y4_H (RO)	
0x23	X4 Coord (Low Byte)				×4_	L(RO)			
	Y4 Coord (Low Byte)				Y4_	L(R0)			

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2.6.6 Device Control Register

Reg Addr.	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0x02	Device Control Reg		Rese	erved		Reserved	Reserved	Power Down (R/W)	Reset (RMV)

Device Control Register provides device control bits for host to reset the device , power down the device.

2.6.7 Timeout to Idle Register

Reg Addr.	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0x03	Timeout to Idle Register				Timeout to (R/				

Timeout to Idle Register provides timeout control to entering Idle Mode for host.

The touch controller will enter Idle Mode after the number of seconds specified in Timeout to Idle Register if there is no touch detected in this period.

Set the field to 0xFF will disable Idle Mode. Set the field to 0 will entering Idle Mode immediately.

The default value of Timeout to Idle Register is set to 0x08 for 8 seconds to Idle Mode.

2.6.8 XY Coordinate Registers

0x12	XYO Coord (High Byte)	Valid 0 (RO)	X0_H(RO)	Reserved	Y0_H (R0)
0x13	X0 Coord (Low Byte)		X0_l	_(R0)	
0x14	Y0 Coord (Low Byte)		Y0_L	_(R0)	
0x15			Res	erved	
0x16 ~ 0x21					
0x22	XY4 Coord (High Byte)	Valid 4 (RO)	X4_H(RO)	Reserved	Y4_H (R0)
0x23	X4 Coord (Low Byte)		X4_L	_(R0)	
0x24	Y4 Coord (Low Byte)		Y4_L	_(R0)	

XY Coordinate Registers represent the XY coordinates for each touch point ID.

Valid bit field tells that this point ID is valid and the XY information represents a real touch point on touch sensor.

3. OPTICAL CHARACTERISTICS

3.1 Characteristics

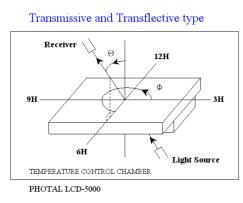
[Item	1	Characteris		ool / temp.	Min.	Тур.	Max.	Unit	Note
1	Response	Time		Tr	25 °C	-	5	10	ms	2
				Tf	25 °C	-	15	20	1115	2
		Hor.		Θ_{2^+}	$\Phi = 0^{\circ}$	60	85	-		
2	Viewing	1101.	Center	θ2-	Ф=180°	60	85	-	degree	3
Z	Angle	Ver.	$CR \ge 10$	Θ_{1^+}	Ф=270°	60	85	-	uegree	5
		ver.		Θ ₁₋	Φ=90°	60	85	-		
3	Contrast R	latio		Cr	25 °C	700	1000	-	-	4
	Red x-cod	e		Rx		0.59	0.64	0.69		
	Red y-cod	e		Ry		0.29	0.34	0.39		
	Green x-co	ode		Gx		0.28	0.33	0.38		
	Green y-co	ode		Gy		0.58	0.63	0.68		5
4	Blue x-coo	de		Bx	25 °C	0.10	0.15	0.20	-	
	Blue y-coo	de		By		0.00	0.05	0.10		
	White x-co	White x-code		Wx		0.25	0.30	0.35		
	White y-code		Wy		0.27	0.32	0.37			
	Brightness			Y		320	450	-	cd/m ²	
5	Brightness Uniformit				25 °C	80	-	-	%	6

Electrical and Optical Characteristics

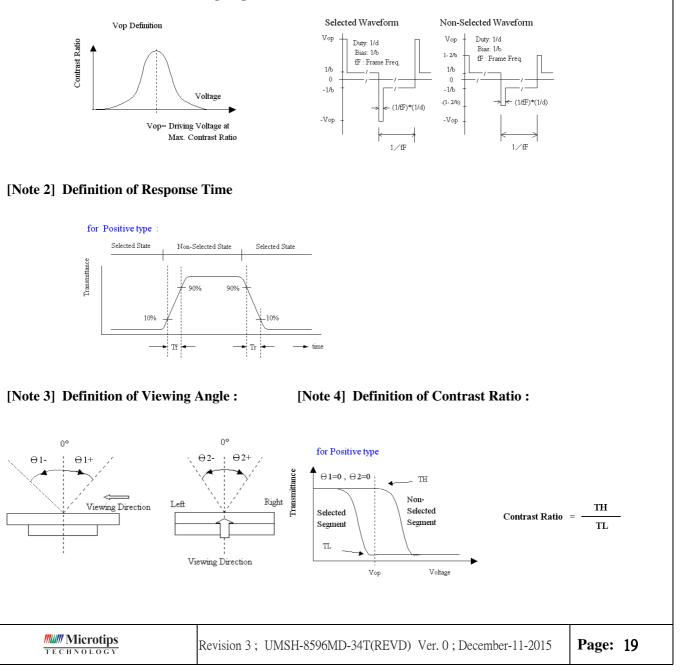
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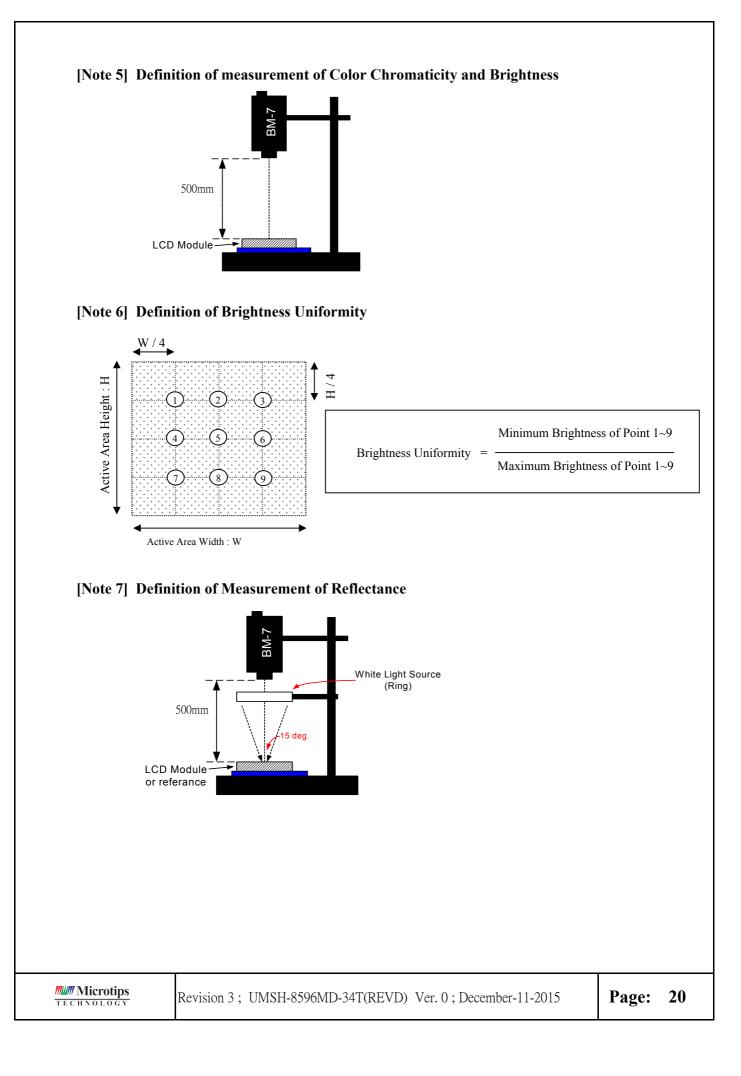
3.2 Definition of optical characteristics

Measurement condition :



[Note 1] Definition of LCD Driving Vop and Waveform :





4. RELIABILITY :

Item No	Items	Condition	Note
1	High temperature operating	$70~^\circ\mathrm{C}$, $200~\mathrm{hours}$	1
2	Low temperature operating	-20 °C , 200 hours	1
3	High temperature storage	$80~^\circ\!\!C$, 200 hours	1
4	Low temperature storage	-30 °C , 200 hours	1
5	High temperature & humidity	60°C, 90%RH, 100 hours	2
6	Thermal Shock storage	-30°C, 30min.<=> 80°C, 30min. 10 Cycles	1
7	Vibration test	$10 \Rightarrow 55 \Rightarrow 10 \Rightarrow 55 \Rightarrow 10 \text{ Hz}$, within 1 minute Amplitude : 1.5mm. 15 minutes for each Direction (X,Y,Z)	
8	Drop test	Packed, 100CM free fall, 6 sides, 1 corner, 3edges	
9	Life time	50,000 hours 25°C, 60%RH, specification condition driving	

Note 1 : The product move into the room temperature for at least 2 hours with no condensation.

Note 2 : The product move into the room temperature for at least 24 hours with no condensation.

- Note 3 : Please change the display picture (autorun) during operating mode. Avoid displaying static images to avoid image sticking , and the image sticking is accelerated by temperature.
 - * One single product test for only one item.
 - * Judgment after test : keep in room temperature for more than 2 hours.
 - Current consumption < 2 times of initial value
 - Contrast > 1/2 initial value
 - Function : work normally

5. PRODUCT HANDLING AND APPLICATION

PRECAUTION FOR HANDLING LCM

- The LCD module contains a C-MOS LSI. People who operate the LCM should wear ESD protection eguipement to prevent ESD hurt on products.
- Do not input any signal before power is turned on.
- Do not take LCM from its packaging bag until it is assembled.
- Peel off the LCM protective film slowly since static electricity may be generated.
- Pay attention to the humidity of the work shop, 50~60%RH is satisfactory.
- Use a non-leak iron for soldering LCM.
- Do not touch the display surface or connection terminals area with bare hands. Smudges on the display surface reduce the insulation between terminals.

• Cautions for soldering to LCM:

Condition for soldering I/O terminals:

Temperature at iron tip : $350^{\circ}C \pm 15^{\circ}C$.

Soldering time : 3~4sec./ terminals.

Type of solder : Eutectic solder(rosin flux filled).

PRECAUTION IN USE OF LCM

- Do not contact or scratch the front surface and the contact pads of a LCM with hard materials such as metal or glass or with one's nail.
- To clean the surface, wipe it gently with soft cloth dampened by alcohol.
- Do not attempt to wiped off the contact pads.
- Keep LCM panels away from direct sunlight, also avoid them in high-temperature & high humidity environment for a long period.
- Do not drive LCM by DC voltage.
- Do not expose LCM to organic solvent.
- Liquid in LCM is hazardous substance. In case a contact with liquid crystal material is occured, be sure to immediately wash such material away by soap and water.
- The polarizer is easily damaged and should be handle with special care. Don't press or rub it with hard objects.

□ PRECAUTION FOR STORING AND USE OF LCM

- To avoid degradation of the device , do not store the module under the conditions of direct sunlight , high temperature or high humidity . Keep the module in bags designed to prevent static electricity charging under low temperature / normal humidity conditions(avoid high temperature / high humidity and low temperature below 0°C)
- Never use the LCD, LCM under 45 Hz, the liquid crystal will decomposition and cause permently damage on display !!

USING ON MEDICAL CARE , SAFETY OR HAZARDOUS APPLICATION OR SYSTEM

- For the application in medical care, safety and hazardous products or systems, an authorization from MT is required. MT will not responsible for any damage or loss which caused by the products without any authorization given by URT.
- This product is not allowed to be designed and used for military application and/or purpose.
- The delivery of this product to the countries and/or regions where the embargoes are imposed by U.N. is prohibited.
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22

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- The application and delivery of this product must comply with Startegic High-Tech Commodities (SHTC) export control and the sales to the embargoed and/or sanctioned countries or regions are strictly prohibited.

Rohs Compliance

This product is RoHS compliance . Follow RoHS Directive 2011/65/EU.

Pb	< 1000 ppm	Pb	: Lead
Cd	< 100 ppm	Cd	: Cadmium
Hg	< 1000 ppm	Hg	: Mercury
Cr ⁶⁺	< 1000 ppm	Cr ⁶⁺	: Chromium VI
PBB	< 1000 ppm	PBB	: Polybrominated biphenyls
PBDE	< 1000 ppm	PBDE	: Polybrominated biphenyl ethers

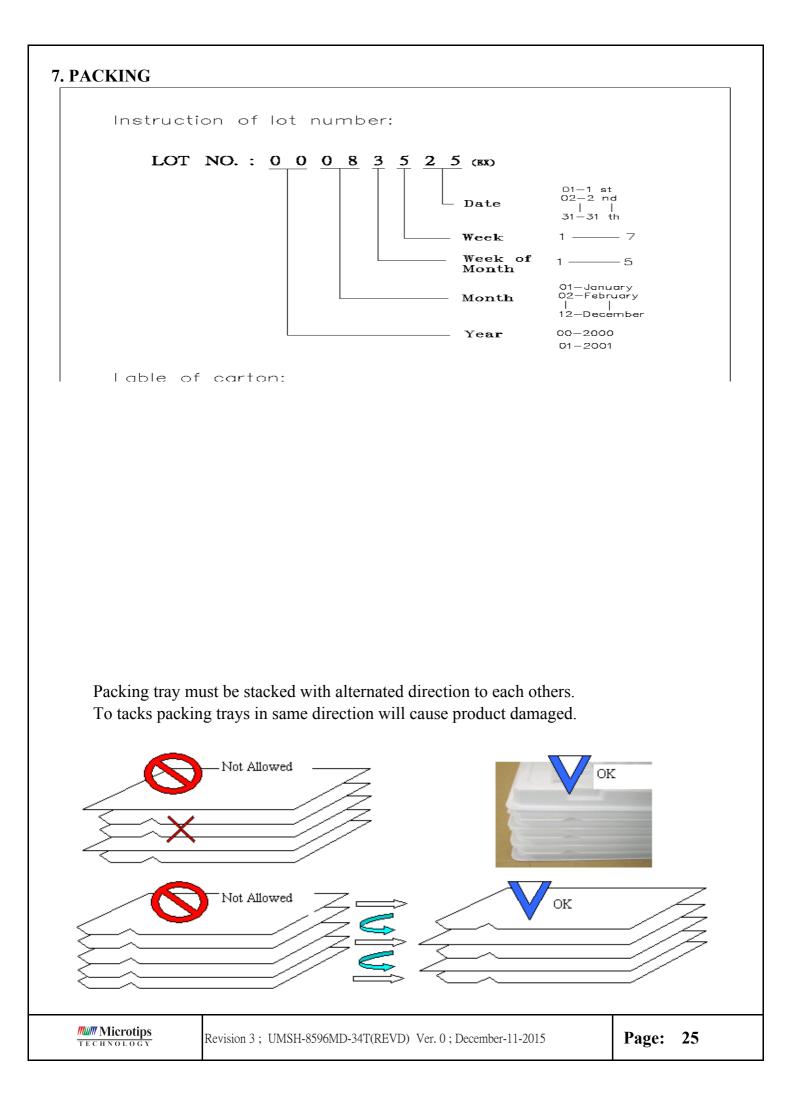
6. DATE CODE OF PRODUCTS

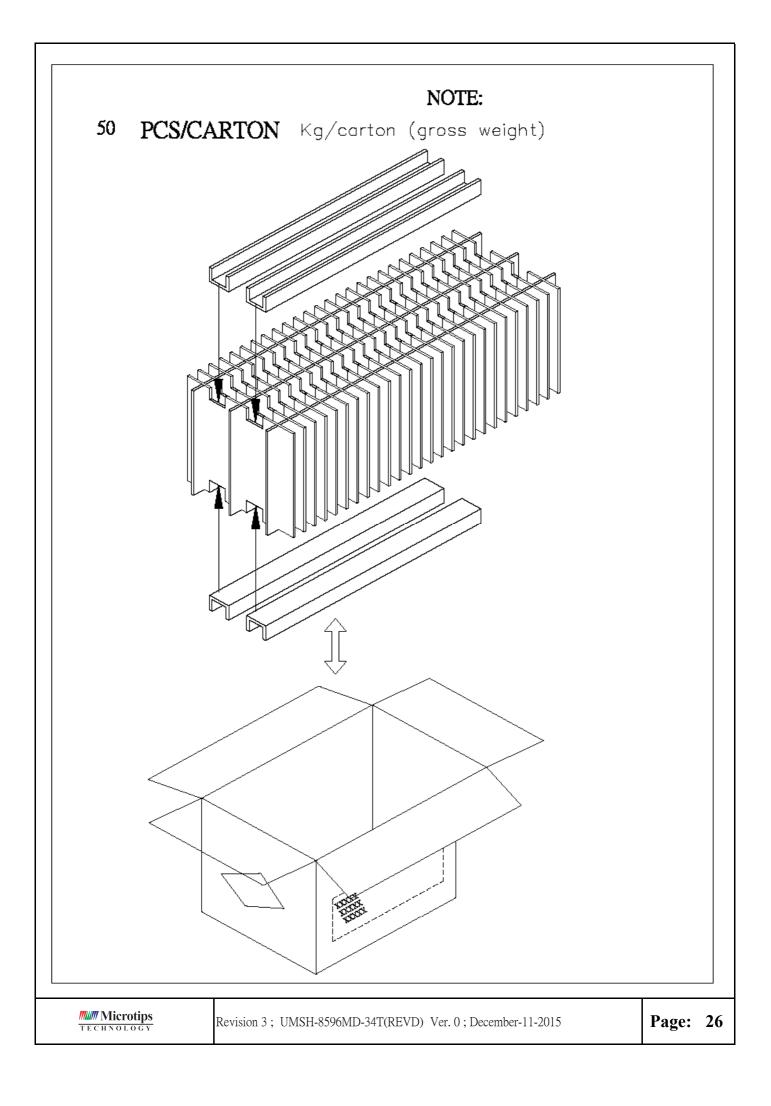
• Date code will be shown on each product :



Year Month Day - Production lots no.

- Example: 141108 0 0 0 3 ==> Year 2014, November,8th, Production lots no.0003
- Note : The lot no. attached on the packing box will be used for tracking once the part is too small to print the date code.





8. INSPECTION STANDARD

8.1. QUALITY :

THE QUALITY OF GOODS SUPPLIED TO PURCHASER SHALL COME UP TO THE FOLLOWING STANDARD. 8.1.1. THE METHOD OF PRESERVING GOODS

AFTER DELIVERY OF GOODS FROM MT TO PURCHASER. PURCHASER SHALL CONTROL THE LCM AT -10 $^\circ$ C to 40 $^\circ$ C ,and it might be desirable to keep at the normal room temperature and humidity until incoming inspection or throwing into process line.

8.1.2. INCOMING INSPECTION

(A) THE METHOD OF INSPECTION

IF PURCHASER MAKE AN INCOMING INSPECTION , A SAMPLING PLAN SHALL BE APPLIED ON THE CONDITION THAT QUALITY OF ONE DELIVERY SHALL BE REGARDED AS ONE LOT.

(B) THE STANDARD OF QUALITY

ISO-2859-1 (SAME AS MIL-STD-105E) , LEVEL $\scriptstyle\rm II$ SINGLE PLAN.

CLASS	AQL(%)
CRITICAL	0.4 %
MAJOR	0.65 %
MINOR	1.5 %
TOTAL	1.5 %

EVERY ITEM SHALL BE INSPECTED ACCORDING TO THE CLASS.

(C) MEASURE

IF AS THE RESULT OF ABOVE RECEIVING INSPECTION, A LOT OUT IS DISCOVERED. PURCHASER SHALL BE INFORM SELLER OF IT WITHIN SEVEN DAYS. BUT FIRST SHIPMENT WITHIN FOURTEEN DAYS.

8.1.3. WARRANTY POLICY

 \boldsymbol{MT} will provide one-year warranty for the products only if under specification

OPERATING CONDITIONS. MT WILL REPLACE NEW PRODUCTS FOR THESE DEFECT PRODUCT WHICH UNDER WARRANTY PERIOD AND BELONG TO THE RESPONSIBILITY OF MT.

8.2. CHECKING CONDITION

8.2.1. CHECKING DIRECTION SHALL BE IN THE 45 DEGREE AREA FROM VIEWING DIRECTION.

8.2.2. CHECKER SHALL SEE OVER 300±25 mm. WITH BARE EYES FAR FROM SAMPLE AND USING 2 PCS. OF 20W FLUORESCENT LAMP.

8.3. INSPECTION PLAN :

CLASS	ITEM	JUDGEMENT	CLASS
PACKING &	1. OUTSIDE AND INSIDE PACKAGE	"MODEL NO." , "LOT NO." AND "QUANTITY" SHOULD INDICATE ON THE PACKAGE.	Minor
INDICATE	2. MODEL MIXED AND QUANTITY	OTHER MODEL MIXEDREJECTED QUANTITY SHORT OR OVERREJECTED	Critical
	3. PRODUCT INDICATION	"MODEL NO." SHOULD INDICATE ON THE PRODUCT	Major
ASSEMBLY	4. DIMENSION, LCD GLASS SCRATCH AND SCRIBE DEFECT.	ACCORDING TO SPECIFICATION OR DRAWING.	Major
	5. VIEWING AREA	POLARIZER EDGE OR LCD'S SEALING LINE IS VISABLE IN THE VIEWING AREA REJECTED	Minor
	6. BLEMISH、BLACK SPOT、 WHITE SPOT IN THE LCD AND LCD GLASS CRACKS	ACCORDING TO STANDARD OF VISUAL INSPECTION (INSIDE VIEWING AREA)	Minor
APPEARANCE	7. BLEMISH \cdot BLACK SPOTACCORDING TO STANDARD OF VISUALWHITE SPOTAND SCRATCHON THE POLARIZERINSPECTION (INSIDE VIEWING AREA)		Minor
	8. BUBBLE IN POLARIZER ACCORDING TO STANDARD OF VISUAL INSPECTION (INSIDE VIEWING AREA)		Minor
	9. LCD'S RAINBOW COLOR	STRONG DEVIATION COLOR (OR NEWTON RING) OF LCDREJECTED. OR ACCORDING TO LIMITED SAMPLE (IF NEEDED, AND INSIDE VIEWING AREA)	Minor
	10. ELECTRICAL AND OPTICAL CHARACTERISTICS (CONTRAST \ VOP \ CHROMATICITY ETC)	ACCORDING TO SPECIFICATION OR DRAWING . (INSIDE VIEWING AREA)	Critical
ELECTRICAL	11.MISSING LINE	MISSING DOT、LINE、CHARACTER REJECTED	Critical
	12.SHORT CIRCUIT、 WRONG PATTERN DISPLAY	NO DISPLAY、WRONG PATTERN DISPLAY、CURRENT CONSUMPTION OUT OF SPECIFICATION REJECTED	Critical
	13. DOT DEFECT (FOR COLOR AND TFT)	ACCORDING TO STANDARD OF VISUAL INSPECTION	Minor

			(A) ROUND TYPE:	unit : mm.	
			DIAMETER (mm.)	ACCEPTABLE Q'TY	
		BLACK AND WHITE SPOT FOREIGN MATERIEL DUST IN THE CELL	$\Phi \leq 0.1$	DISREGARD	
			$0.1 < \Phi \leq 0.25$	3(Distance>5mm)	
8.4.1 MI	MINOR		0.25 < Φ	0	
			NOTE: $\Phi = (\text{LENGTH} + \text{WID})$	[H)/2	
		BLEMISH	(B) LINEAR TYPE:	unit : mm.	
		SCRATCH	LENGTH WIDTH	ACCEPTABLE Q'TY	
				≦0.03 DISREGARD	
				≤ 0.07 3(Distance>5mm)	
			0.07< W	FOLLOW ROUND TYPE	
			DIAMETER	unit : mm. ACCEPTABLE Q'TY	
	MINOR BUBBLE IN POLARIZER	$\Phi \leq 0.2$	DISREGARD		
8.4.2		DENT ON POLARIZER	$\begin{array}{ccc} \Phi & \equiv 0.2 \\ \hline 0.2 < & \Phi & \leq 0.5 \end{array}$	2(Distance>5mm)	
			$0.5 < \Phi$	0	
			0.0 4		
	Dot Defect		Items	ACC. Q'TY	
		Bright dot	$N \leq 4$ (Distance>5mm)		
			Dark dot	$N \leq 4$ (Distance>5mm)	
8.4.3	MINOR		Pixel Define : Pixel Differe : Pixel	B → ← Dot → ze of a defective dot over as one defective dot. ht and unchanged in size aying under black pattern. and unchanged in size in	

	CLASS	ITEM	JUDGEMENT	Γ
8.4.4	MINOR	LCD GLASS CHIPPING	T X X	Y > S Reject
8.4.5	MINOR	LCD GLASS CHIPPING	S X S	X or Y > S Reject
8.4.6	MAJOR	LCD GLASS GLASS CRACK	Y Y	Y > (1/2) T Reject
8.4.7	MAJOR	LCD GLASS SCRIBE DEFECT	$A_{\frac{1}{7} \leftarrow a^{-1}}^{\underline{k}} \xrightarrow{L \longrightarrow A}_{\frac{1}{7} \leftarrow B}$	 a> L/3 , A>1.5mm. Reject B : ACCORDING TO DIMENSION
8.4.8	MINOR	LCD GLASS CHIPPING (ON THE TERMINAL AREA)	T	$\Phi = (x+y)/2 > 2.5 \text{ mm}$ Reject
8.4.9	MINOR	LCD GLASS CHIPPING (ON THE TERMINAL SURFACE)	T Z X	Y > (1/3) T Reject
3.4.10	MINOR	LCD GLASS CHIPPING	X ->	Y > T Reject

.5.2 M	MAJOR	Touch Panel Chipping	Edge		Products $Z <$ CNCFor CNCProductsDirNot CNC $X \leq 3mm$, $Z <$ CNCFor CNCCNCFor CNC	RejectY \leq 2mm, 1/2TAcceptC Outline mensionAcceptY \leq 3mm, 1/2TAcceptC Outline C OutlineAccept
3.5.3 M		Chipping Dust and	Edge		Products $Z <$ CNCFor CNCProductsDirNot CNC $X \leq 3mm$, $Z <$ Products $Z <$ CNCFor CNC	$1/2T$ AcceptC Outline nensionAcceptY \leq 3mm, 1/2TAccept
8.5.3 M		Dust and			ProductsZ <CNCFor CNC	1/2T Accept
	MINOR				Products Dir	nension Accept
	MINOR		H	W≦0.05, I	$L \leq 10 mm$	Accept
3.5.4 M			Scratch d Foreign material .inear Type)		07 mm; L \leq 5.0mm en seratch > 5.0mm	Accept 3 ea Max.
8.5.4 M				W>(0.07mm	Reject
8.5.4 M		Scratch IINOR Dust and Foreign material (Round Type : ⊕=(Length+Width)/2)		$\Phi \leq$	0.15mm	Accept
	MINOR			$\Phi \leq 0.25$ mm en seratch > 5.0mm	Accept 5 ea Max.	
		$\Phi >$	0.25mm	Reject		
8.5.5 MINOR		Touch Panel INOR Dent / Fish Eyes (Φ=(Length+Width)/2)	$\Phi \leq 0.2$	35mm	Accept	
	MINOR		0.35mm < 0 Distance		Accept 3 ea Max.	
				$\Phi > 1$.0mm	Reject
	MINOR			$\Phi \leq 0.$	15mm	Accept
8.5.6 M		$\begin{array}{c} \text{Touch Panel} \\ \text{IINOR} & \text{Air Bubble} \\ (\Phi = (\text{Length} + \text{Width})/2) \end{array}$	0.15 mm $< \Phi$ Distance between		Accept 3 ea Max.	
			<i>c , , ,</i>	$\Phi > 0.1$	25mm	Reject
			W≦0.03, I	$L \leq 10 mm$	Accept	
8.5.7 MINOR	MINOR Touch Panel Printing area Scratch	0.03 mm $<$ W \leq	0.05mm, L \leq 5mm	Accept 3 ea Max.		
				nm or L>5mm v 8.5.4 Round type)	Reject	
8.5.8 M	MINOR	Touch Panel White Haze Mark / Dust		Can not be	e removed	Reject
1	I					

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